# SM802124



ClockWorks™ DUAL 125MHz Ultra-Low Jitter, CMOS Frequency Synthesizer

#### **General Description**

The SM802124 is a member of the ClockWorks<sup>™</sup> family of devices from Micrel and provides an extremely low-noise timing solution for Ethernet clock signals. It is based upon a unique patented RotaryWave<sup>®</sup> architecture that provides very-low phase noise.

The device operates from a 3.3V or 2.5V power supply and synthesizes two CMOS output clocks at 125MHz from a 15MHz LVCMOS reference clock.

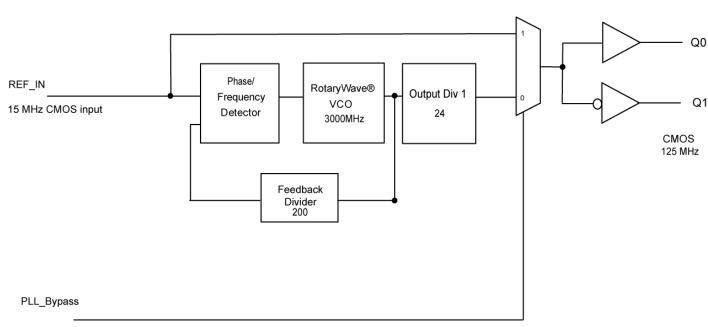
Data sheets and support documentation can be found on Micrel's web site at: <u>www.micrel.com</u>.

#### **Features**

- Generates two LVCMOS clock outputs at 125MHz
- 2.5V or 3.3V operating range
- Typical rms phase jitter @ 125MHz 1.875MHz to 20MHz : 85fs (Input source dependent)
- Industrial temperature range (-40°C to +85°C)
- Green, RoHS, and PFOS compliant
- Available in 24-pin 4mm × 4mm QFN package

#### Applications

• Gigabit Ethernet



(Internal Pulldown)

Block Diagram

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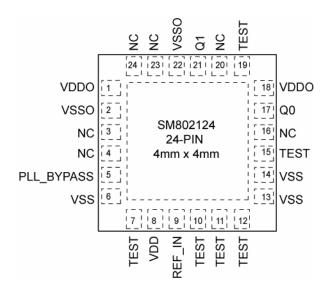
## Ordering Information<sup>(1)</sup>

Part Number	Marking	Shipping	Temperature Range	Package
SM802124UMG	802124	Tube	–40°C to +85°C	24-Pin QFN
SM802124UMGTR	802124	Tape and Reel	–40°C to +85°C	24-Pin QFN

Note:

1. Devices are Green, RoHS, and PFOS compliant.

### **Pin Configuration**



24-Pin QFN (code) (Top View)

## **Pin Description**

Pin Number	Pin Name	Pin Type	Pin Level	Pin Function
17	Q0	0	CMOS	125MHz Clock Output
21	Q1	0	CMOS	180 deg,125MHz Clock Output
3, 4, 16 , 20, 23, 24	NC	-	-	No Connection. Do not connect anything to these pins.
1, 18	VDDO	PWR		Power Supply for Output
2, 22	VSSO	PWR		Power Supply Ground for Output
				PLL Bypass, Selects Output Source
5	PLL BYPASS	I, (SE)	LVCMOS	0 = Normal PLL Operation
5	FLL_DTFA33	, (SE)	LVCIVIOS	1 = Output from Input Reference Clock
				45KΩ pull-down
7, 10, 11, 12, 15, 19	TEST			Factory Test pins, Do not connect anything to these pins.
8	VDD	PWR		Core Power Supply
6, 13 , 14	VSS	PWR		Core Power Supply Ground
9	REF_IN	I, (SE)	LVCMOS	Reference Clock Input

## Absolute Maximum Ratings<sup>(1)</sup>

Supply Voltage (V <sub>DD</sub> , V <sub>DDO</sub> )	+4.6V
Input Voltage (V <sub>IN</sub> )	–0.50V to V <sub>DD</sub> + 0.5V
Lead Temperature (soldering, 20s).	260°C
Case Temperature	115°C
Storage Temperature (T <sub>s</sub> )	65°C to +150°C

### **Operating Ratings**<sup>(2)</sup>

Supply Voltage (V <sub>DD</sub> , V <sub>DDO</sub> )	+2.375V to +3.465V
Ambient Temperature (T <sub>A</sub> )	–40°C to +85°C
Junction Thermal Resistance <sup>(3)</sup>	
QFN (θ <sub>JA</sub> )	
Still-Air	
QFN (ψ <sub>JB</sub> )	
Junction-to-Board	

### DC Electrical Characteristics<sup>(4)</sup>

 $V_{\text{DD}}$  =  $V_{\text{DDO}}$  = 3.3V  $\pm 5\%$  or 2.5V  $\pm 5\%$ 

 $V_{DD} = 3.3V \pm 5\%, V_{DDO} = 2.5V \pm 5\%$ 

 $T_A = -40^{\circ}C \text{ to } +85^{\circ}C.$ 

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
$V_{DD}, V_{DDO}$	2.5V Operating Voltage		2.375	2.5	2.625	V
V <sub>DD</sub> , V <sub>DDO</sub>	3.3V Operating Voltage		3.135	3.3	3.465	V
I <sub>DD</sub>	Supply current V <sub>DD</sub> + V <sub>DDO</sub>	Outputs open		70	90	mA

### LVCMOS OUTPUT DC Electrical Characteristics<sup>(4)</sup>

 $V_{DD}$  =  $V_{DDO}$  = 3.3V  $\pm 5\%$  or 2.5V  $\pm 5\%$ 

 $V_{DD}$  = 3.3V ±5%,  $V_{DDO}$  = 2.5V ±5%

 $T_A = -40^{\circ}C$  to  $+85^{\circ}C$ .  $R_L = 50\Omega$  to  $V_{DDO}/2$ .

Symbol	Parameter	Condition	Min	Тур	Max	Units
V <sub>OH</sub>	Output High Voltage	Fig. 4	V <sub>DD</sub> -0.7			V
V <sub>OL</sub>	Output Low Voltage	Fig. 4			0.6	V

### LVCMOS (PLL\_BYPASS) DC Electrical Characteristics<sup>(4)</sup>

 $V_{DD}$  = 3.3V ±5%, or 2.5V ±5%,  $T_A$  = -40°C to +85°C.

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
V <sub>IH</sub>	Input High Voltage		2		V <sub>DD</sub> + 0.3	V
V <sub>IL</sub>	Input Low Voltage		-0.3		0.8	V
I <sub>IH</sub>	Input High Current	$V_{DD} = V_{IN} = 3.465V$			150	μA
IIL	Input Low Current	V <sub>DD</sub> = 3.465V, V <sub>IN</sub> = 0V	-5			μA

### **REF\_IN DC Electrical Characteristics**<sup>(4)</sup>

 $V_{DD}$  = 3.3V ±5%, or 2.5V ±5%,  $T_A$  = -40°C to +85°C.

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
V <sub>IH</sub>	Input High Voltage		1.1		V <sub>DD</sub> + 0.3	V
V <sub>IL</sub>	Input Low Voltage		-0.3		0.6	V
I <sub>IN</sub>	Input Current	$V_{IN} = 0V$ to $V_{DD}$	-5		5	μA

## AC Electrical Characteristics<sup>(4, 5)</sup>

 $V_{DD} = V_{DDO} = 3.3V \pm 5\%$  or  $2.5V \pm 5\%$  $V_{DD} = 3.3V \pm 5\%$ ,  $V_{DDO} = 2.5V \pm 5\%$  $T_A = 40^{\circ}$ C to  $85^{\circ}$ C.  $R_L = 50\Omega$  to  $V_{DDO}/2$ 

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
Fout	Output Frequency			125		MHz
F <sub>REF</sub>	Reference Input Frequency			15		MHz
T <sub>R</sub> /T <sub>F</sub>	LVCMOS Output Rise/Fall Time	20% – 80%	100	300	500	ps
ODC	Output Duty Cycle		45	50	55	%
TLOCK	PLL Lock Time				20	ms
T <sub>jit</sub> (∅)	RMS Phase Jitter <sup>(6)</sup>	Integration Range (1.875MHz – 20MHz) Integration Range (12kHz – 20MHz)		85 320		fs
	Spurious Noise Components	5MHz 10MHz 20MHz 25MHz		-73 -82 -89 -96		dBc

Notes:

1. Permanent device damage may occur if absolute maximum ratings are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2. The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.

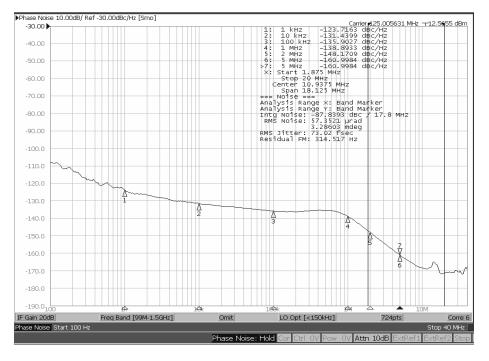
3. Package thermal resistance assumes exposed pad is soldered (or equivalent) to the devices most negative potential on the PCB.

4. The circuit is designed to meet the AC and DC specifications shown in the above table after thermal equilibrium has been established.

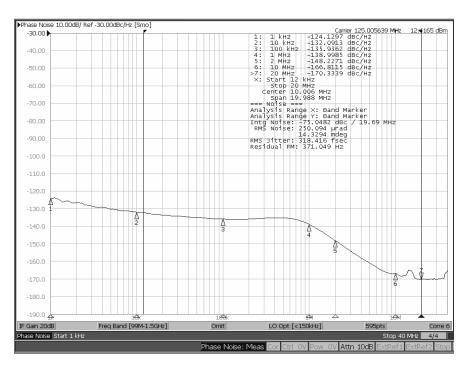
5. All phase-noise measurements were taken with an Agilent 5052B phase-noise system.

6. Ref\_IN driven with a low-noise source ClockWorks SM802001 programmed for a 15MHz CMOS output. Phase noise will track the input phase noise up to about 1MHz offset frequency.

#### **Phase Noise Plots**

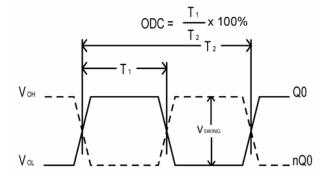


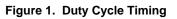
Phase Noise Plot: 125MHz, 1.875MHz – 20MHz 73fS



Phase Noise Plot: 125MHz, 12kHz - 20MHz 318fS

#### **Timing Diagrams**





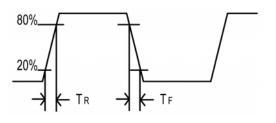


Figure 2. All outputs Rise/Fall Time

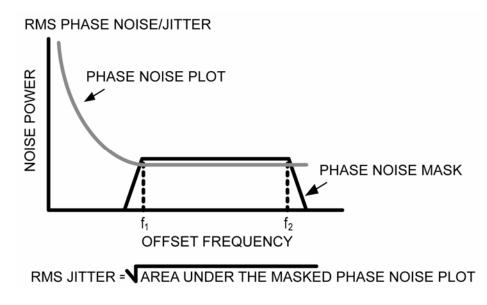


Figure 3. RMS Phase/Noise Jitter

#### Input and Output Stage

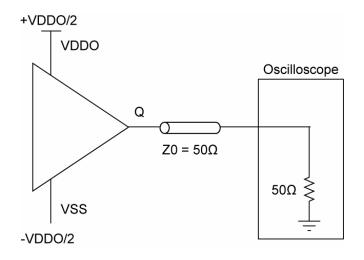
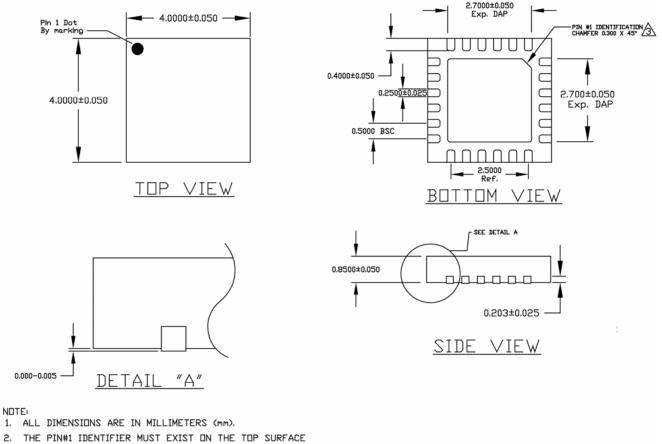


Figure 4. CMOS Output Load and Test Circuit

#### **Package Information**



- THE PIN#1 IDENTIFIER MUST EXIST ON THE TOP SURFAC OF PACKAGE BY USING IDENTIFICATION MARK OR OTHER FEATURE OF PACKAGE BODY.
- 🖄 CHAMFER STYLE PIN 1 IDENTIFIER ON BOTTOM SIDE

24-Pin Package Type

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